

HOSTAFORM®

Chemical abbreviation according to ISO 1043-1: POM Molding compound ISO 29988- POM-K, M-GNS, 03-002 POM copolymer Injection molding type, modified with molybdenum disulphide; good chemical resistance to solvents, fuel and strong alkalis as well as good hydrolysis resistance; high resistance to thermal and oxidative degradation. UL-registration in natural and a thickness more than 1.57 mm as UL 94 HB, temperature index UL 746 B electrical 105 °C, mechanical 90 °C (tensile impact) and 80 °C (tensile). Burning rate ISO 3795 and FMVSS 302 < 100 mm/min for a thickness more than 1 mm. Ranges of applications: For sliding combinations with high surface pressure and low sliding speed, only slight tendency to stick-slip. UL = Underwriters Laboratories (USA) FMVSS = Federal Motor Vehicle Safety Standard (USA)

Product information

Resin Identification Part Marking Code	POM >POM<		ISO 1043 ISO 11469
Rheological properties			
Melt volume-flow rate	8.5	cm ³ /10min	ISO 1133
Temperature	190	-	
Load	2.16		
Moulding shrinkage, parallel	2.0		ISO 294-4, 2577
Moulding shrinkage, normal	1.8	%	ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus	2800	MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	65	MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	9		ISO 527-1/-2
Nominal strain at break	20		ISO 527-1/-2
Flexural modulus	2700		ISO 178
Tensile creep modulus, 1h	2400		ISO 899-1
Tensile creep modulus, 1000h Charpy impact strength, 23°C	1200	MPa kJ/m ²	ISO 899-1 ISO 179/1eU
Charpy impact strength, -30°C		kJ/m ²	ISO 179/1eU
Charpy notched impact strength, 23°C		kJ/m ²	ISO 179/1eO
Charpy notched impact strength, -30 °C		kJ/m ²	ISO 179/1eA
Ball indentation hardness, H 358/30		MPa	ISO 2039-1
Poisson's ratio	0.4 ^[OT]		
[OT]: One time tested			
Thermal properties			
Melting temperature, 10°C/min	166	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	100	°C	ISO 75-1/-2
Coefficient of linear thermal expansion	110	E-6/K	ISO 11359-1/-2
(CLTE), parallel			
Flammability			
Burning Behav. at 1.5mm nom. thickn.	HB	class	IEC 60695-11-10
Thickness tested		mm	IEC 60695-11-10
Burning Behav. at thickness h	HB	class	IEC 60695-11-10
Thickness tested	3.18	mm	IEC 60695-11-10
UL recognition	yes		UL 94



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Relative permittivity, 100Hz	4.2		IEC 62631-2-1
Relative permittivity, 1MHz	4.2		IEC 62631-2-1
Dissipation factor, 100Hz	25	E-4	IEC 62631-2-1
Dissipation factor, 1MHz	80	E-4	IEC 62631-2-1
Volume resistivity	1E12	Ohm.m	IEC 62631-3-1
Surface resistivity	1E14	Ohm	IEC 62631-3-2
Electric strength	35	kV/mm	IEC 60243-1
Comparative tracking index	600		IEC 60112
Physical/Other properties			
Humidity absorption, 2mm	0.2	%	Sim. to ISO 62
Water absorption, 2mm	0.75	%	Sim. to ISO 62
Density	1420	kg/m³	ISO 1183
Injection			
Drying Recommended	no		
Drying Temperature	100	°C	
Drying Time, Dehumidified Dryer	3 - 4	h	
Processing Moisture Content	≤0.2	%	
Melt Temperature Optimum	200	°C	
Min. melt temperature	190	°C	
Max. melt temperature	210	°C	
Screw tangential speed	≤0.3	m/s	
Mold Temperature Optimum	100	°C	
Min. mould temperature	80	°C	
Max. mould temperature	120	°C	
Hold pressure range	60 - 120	MPa	
Back pressure	2	MPa	
Observation de la construction			

Characteristics

Processing	Injection Moulding, Other Extrusion
Delivery form	Pellets
Special characteristics	Low wear / Low friction

Additional information

Injection molding

Preprocessing	

General drying is not necessary due to low moisture absorption of the resin.

In case of bad storage conditions (water contact or condensed water) the use of a recirculating air dryer (100 to 120 °C / max. 40 mm layer / 3 to 6 hours) is recommended.

Max. Water content 0,2 %





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Processing

Standard injection moulding machines with three phase (15 to 25 D) plasticating screws will fit.

Postprocessing

Conditioning e.g. moisturizing is not necessary.

Processing Notes

Pre-Drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

Storage

The product can then be stored in standard conditions until processed.

Automotive

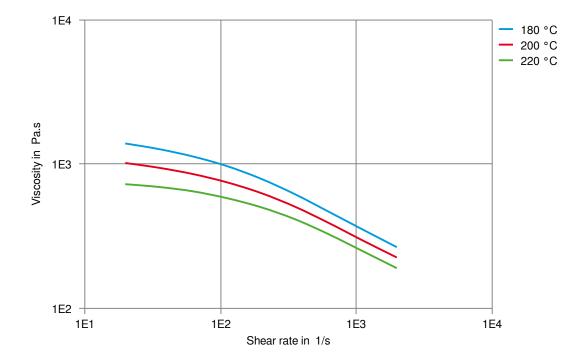
OEM BMW	STANDARD GS93016	ADDITIONAL INFORMATION
Bosch	N28 BN22-O014	Natural
Continental	TST N 055 54.07	
Stellantis - Chrysler	MS.50095 / CPN-5280	Canod





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Viscosity-shear rate

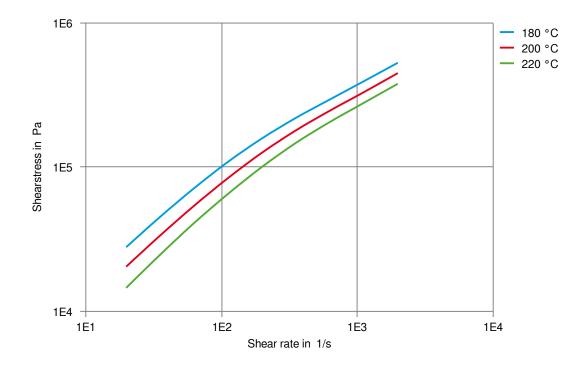






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Shearstress-shear rate

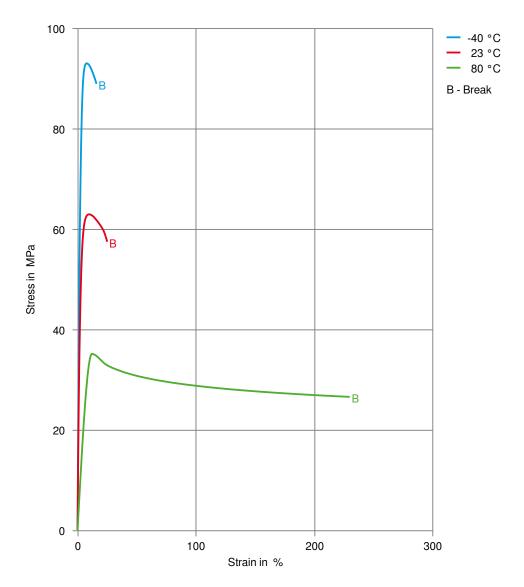






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Stress-strain

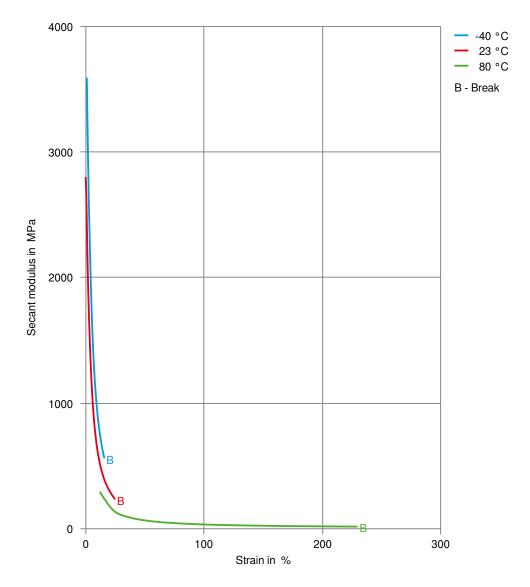






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Secant modulus-strain



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